

## Understanding of Subthreshold Swing of Si n-MOSFETs over a Temperature Range from 300 to 38 K

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**[Background]** Attention has recently been paid to the operation of Si MOSFETs at cryogenic temperature, because of the application of Si CMOS to quantum computing system. Thus, understanding of electrical characteristics of MOSFETs at low temperatures is mandatory. Particularly, the behaviors of subthreshold swing (SS) at low temperatures, which have been reported to have peculiar temperature and  $I_d$  dependencies [1-3], are one of the key factors in physical understanding of the properties of cryogenic CMOS. In order to explain SS of Si n-MOSFETs at deep-cryogenic temperatures, which does not follow the Boltzmann thermal limit of,  $(k_B T/q) \ln 10$ , Beckers *et al.* have proposed models of band tail states [2] and localized states with Gaussian distribution near the band edge [3]. However, the validity of those models has been confirmed in SS in a limited temperature range under a given device condition and, thus, the effectiveness has not been proven over a wide range of temperatures and device parameters. In this study, we evaluate SS of Si n-MOSFETs with a substrate boron concentration of  $2 \times 10^{17} \text{ cm}^{-3}$  as a function of  $I_d$  at temperatures from 300 to 38 K. We apply the SS model including band tail states and localized states, proposed by Beckers *et al.* [2, 3], to the SS values taken over a wide range of temperature and  $I_d$  and examine the effectiveness.

**[Experiments]** N-channel MOSFETs on (100) Si wafers were used for the measurements. The gate stack was composed of  $n^+$ -poly Si and thermally grown  $\text{SiO}_2$ . Here, the substrate boron concentration and the thickness of  $\text{SiO}_2$  was  $2 \times 10^{17} \text{ cm}^{-3}$  and 25 nm, respectively. The channel length/width was  $50 \mu\text{m}/100 \mu\text{m}$ .

**[Results]** Fig. 1-3 show the experimental  $I_D$ - $V_G$ , SS- $I_D$  and SS-temperature characteristics, respectively. We have experimentally confirmed that, at temperature lower than 100 K, SS tend to saturate with decreasing temperature. In order to quantitatively represent the experimental SS values, we have employed the model of mobile tail states in the vicinity of the conduction band edge and localized interface states with a Gaussian distribution, schematically shown in Fig. 4 [3]. Here, the density-of-states (DOS) of the conduction band including band tails are represented by  $\text{DOS}^{2D}(E)$  for  $E > E_c$  and  $\text{DOS}^{2D}(E) \exp((E_c - E)/W_t)$  for  $E < E_c$ . Also, the energy distribution of interface states is assumed by the Gaussian function with an amplitude  $N_0$  and a standard deviation  $W_0/2$ . The simulated SS are also plotted as solid curves in Fig. 1-3. Here,  $W_0$  of 60 meV,  $N_0$  of  $1.5 \times 10^{11} \text{ cm}^{-2}$  and  $W_t$  of 4.5 meV are assumed. It is found that the simulated SS can well represent the experimental SS over a wide range of temperature and  $I_d$ . This fact indicates that the present mobile and localized state model is effective as a physical model of mobile and localized states at Si MOS interfaces.

**[Conclusion]** The SS values of Si n-MOSFETs have been experimentally determined in a temperature range of 300 to 38 K and compared with the simulated results. The good agreement suggests the effective of the existing model composed of the mobile tail states and Gaussian-shape localized interface states.

**[References]** [1] Beckers *et al.*, IEEE J-EDS, 6 (2018) 1007 [2] Beckers *et al.*, IEEE EDL, 41 (2020) 276 [3] Beckers *et al.*, IEEE TED, 67 (2020) 1357

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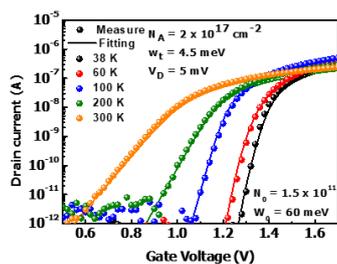


Fig. 1 Comparison of the  $I_D$ - $V_G$  characteristics in measured device (points) and fitting data (solid lines)

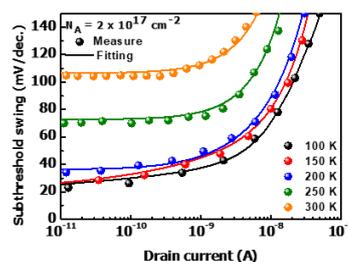


Fig. 2 The SS- $I_D$  characteristics in measured device (points) and fitting data (solid lines)

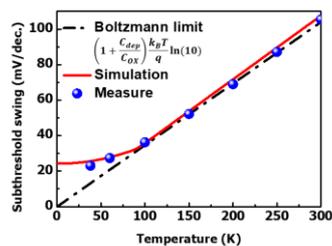


Fig. 3 SS-T plotted data at  $I_D = 10 \text{ pA}$ , black line is Boltzmann limit involved  $C_{dep}$

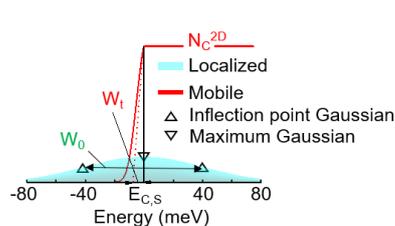


Fig. 4 Zoomed-in on the conduction band at the surface